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May 2013

# FDB86135 N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET 100V, 176A, 3.5mΩ

## Features

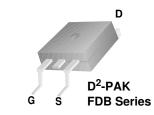
- Shielded Gate MOSFET Technology
- Max  $R_{DS(on)}$  = 3.5m $\Omega$  at  $V_{GS}$  = 10V, I<sub>D</sub> = 75A
- Fast Switching Speed
- Low Gate Charge
- High Performance Trench Technology for Extremely Low  $R_{\text{DS}(\text{on})}$
- High Power and Current Handling Capability
- RoHS Compliant

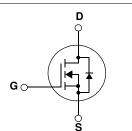
# **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench<sup>®</sup> process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and yet maintain superior switching performance.

# Applications

- DC-DC primary bridge
- DC-DC Synchronous rectification
- Hot swap





### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DSS</sub>	Drain to Source Voltage			100	V	
V <sub>GSS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Curren - Continuous (Silicon Limited) $T_{C} = 25^{\circ}C$			176	A	
	- Continuous( Package Limited) T <sub>C</sub> = 25°C			120		
	- Continuous		T <sub>C</sub> = 25 <sup>o</sup> C(Note 1a)	75		
	- Pulsed			704	Α	
E <sub>AS</sub>	Single Pulsed Avalanche Energy		(Note 3)	658	mJ	
P <sub>D</sub>	Power Dissipation	- T <sub>C</sub> = 25°C	(Note 1a)	227	W	
		- T <sub>A</sub> = 25 <sup>o</sup> C	(Note 1b)	2.4	W/ºC	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +175	°C	

# **Thermal Characteristics**

Symbol	Parameter	Ratings	Units		
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case (N	Note 1)	0.66	°C/W	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient (N	Note 1a)	62.5	-0/10	

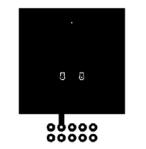
# Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB86135	FDB86135	D2-PAK	330mm	24mm	800

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Charac	teristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A$ , $V_{GS} = 0V$ , $T_C = 25^{\circ}C$	100	-	-	V
ΔBV <sub>DSS</sub> ΔT <sub>J</sub>	Breakdown Voltage Temperature Coefficient	$I_D$ = 250µA, Referenced to 25°C	-	0.07	-	V/ºC
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80V, V <sub>GS</sub> = 0V	-	-	1	μA
I <sub>GSS</sub>	Gate to Body Leakage Current	$V_{GS}$ = ±20V, $V_{DS}$ = 0V	-	-	±100	nA
On Charac	teristics					
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA	2.0	-	4.0	V
R <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10V, I <sub>D</sub> = 75A	-	3.0	3.5	mΩ
9FS	Forward Transconductance	V <sub>DS</sub> = 10V, I <sub>D</sub> = 75A	-	167	-	S
C <sub>iss</sub> C <sub>oss</sub>	Input Capacitance Output Capacitance		-	5485 2430	7295 3230	pF pF
		$V_{DS} = 25V, V_{CS} = 0V$	-			
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1MHz	-	210	-	p. pF
Q <sub>g(tot)</sub>	Total Gate Charge at 10V		-	89	116	nC
Q <sub>gs</sub>	Gate to Source Gate Charge	V <sub>DS</sub> = 80V, I <sub>D</sub> = 75A	-	24	-	nC
Q <sub>gs2</sub>	Gate Charge Threshold to Plateau	$V_{GS} = 10V$	-	8	-	nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge		-	25	-	nC
	Characteristics			1	I	1
t <sub>d(on)</sub>	Turn-On Delay Time		-	22	54	ns
t <sub>r</sub>	Turn-On Rise Time	— V <sub>DD</sub> = 50V, I <sub>D</sub> = 75A — V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 4.7Ω	-	54	118	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$v_{GS} = 10v, r_{GEN} = 4.732$	-	37	84	ns
t <sub>f</sub>	Turn-Off Fall Time		-	11	32	ns
Drain-Sou	rce Diode Characteristics					
V <sub>SD</sub>	Drain to Source Diode Forward Voltage	V <sub>GS</sub> = 0V, I <sub>SD</sub> = 75A (Note 2)	-	-	1.25	V
t <sub>rr</sub>	Reverse Recovery Time	V <sub>GS</sub> = 0V, I <sub>SD</sub> = 75A, V <sub>DD</sub> = 80V	-	72	-	ns
Q <sub>rr</sub>	Reverse Recovery Charge	dl <sub>F</sub> /dt = 100A/μs	-	129	-	nC

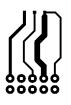
NOTES:

1.  $R_{0JA}$  is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{0JC}$  is guaranteed by design while  $R_{0CA}$  is determined by the user's board design.



2. Pulse Test: Pulse Width < 300  $\mu$ s, Duty cycle < 2.0 %. 3. Starting T\_J = 25 °C, L = 1 mH, I\_{AS} = 36.3 A, V\_{DD} = 100 V, V\_{GS} = 10 V.

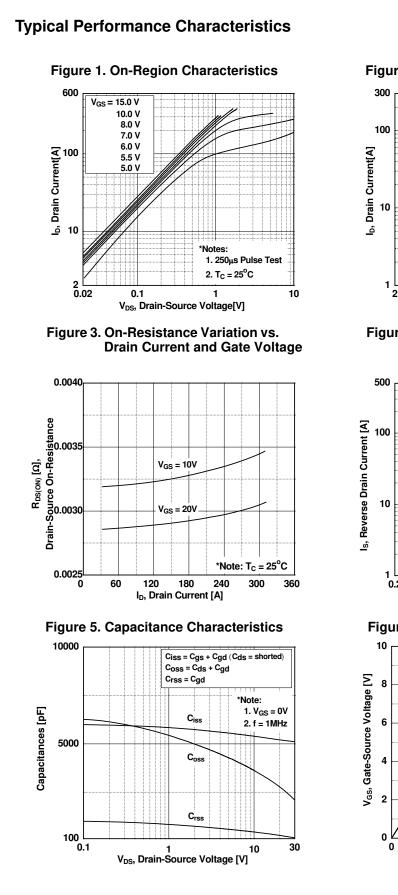
a) 40 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



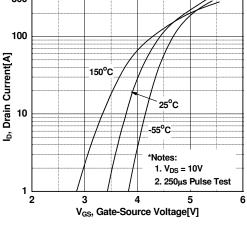
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b) 62.5 °C/W when mounted on a minimum pad of 2 oz copper

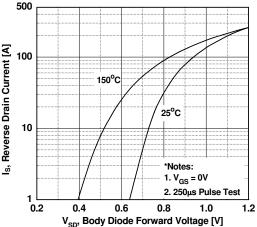




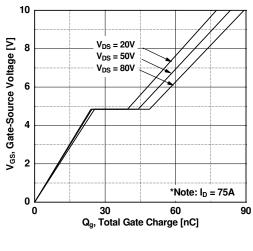
### Figure 2. Transfer Characteristics

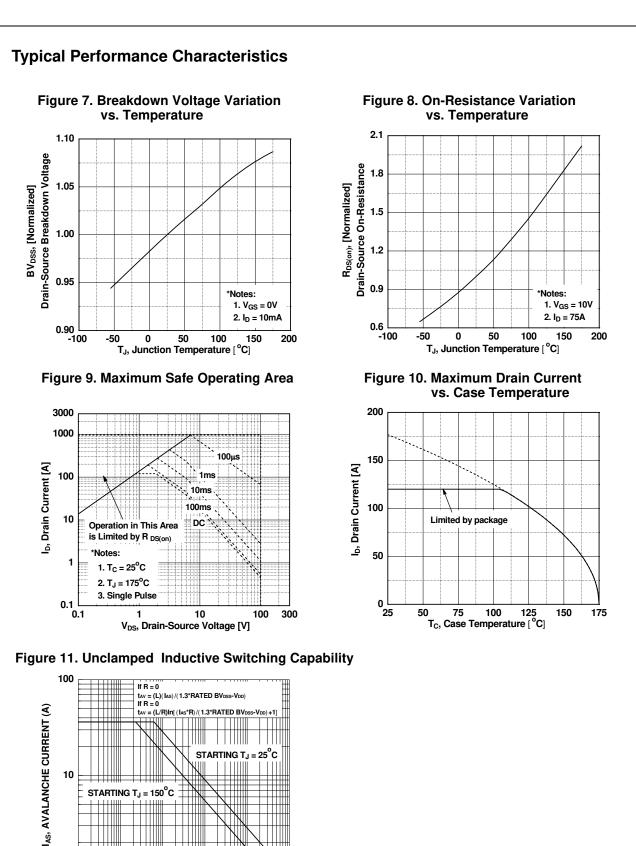






### Figure 6. Gate Charge Characteristics







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STARTING T<sub>J</sub> = 150°C

0.1

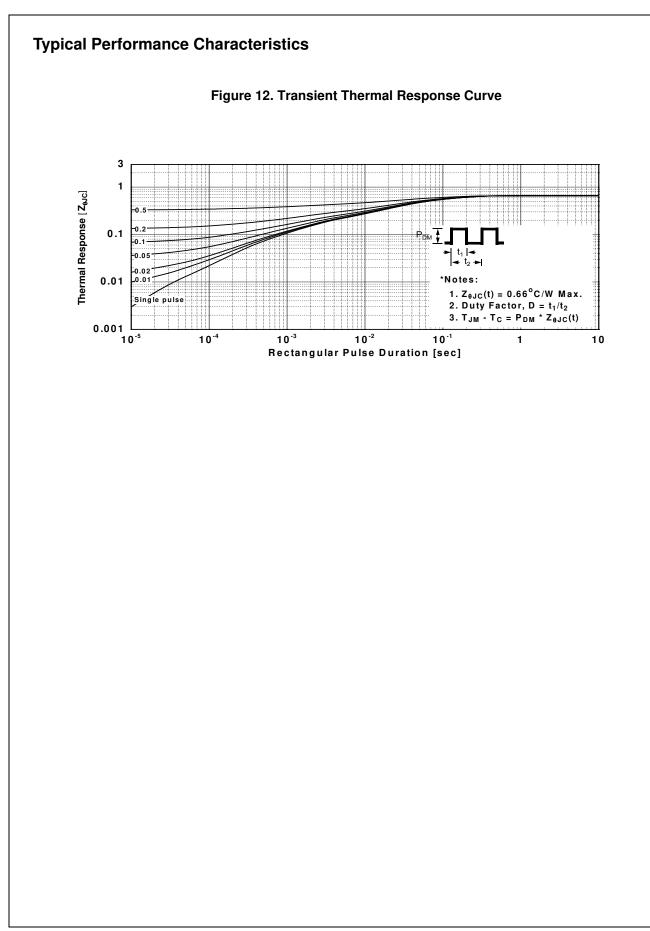
1 t<sub>AV</sub>, TIME IN AVALANCHE (ms)

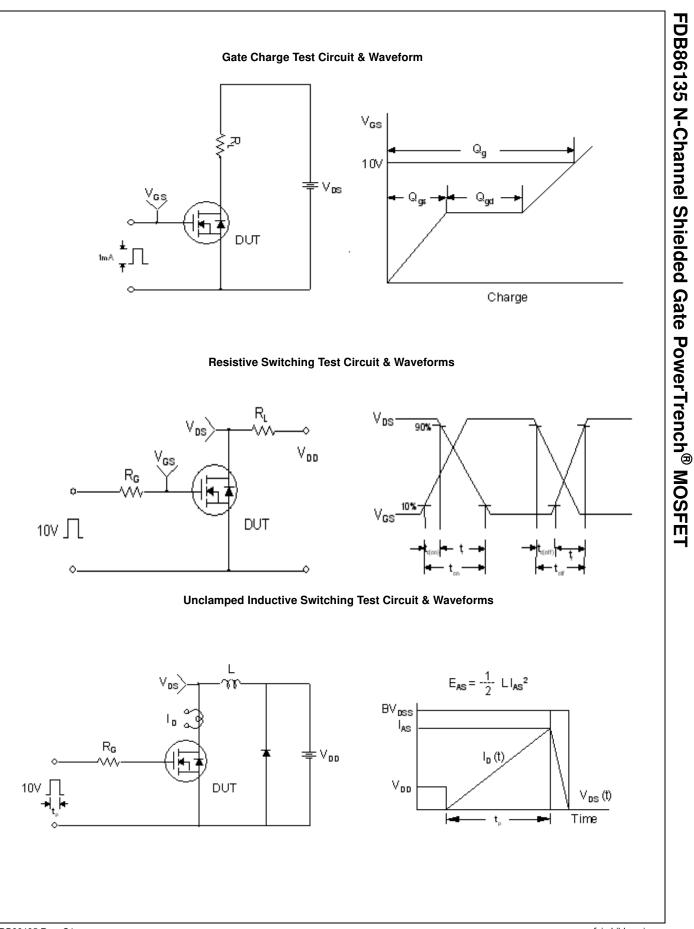


100

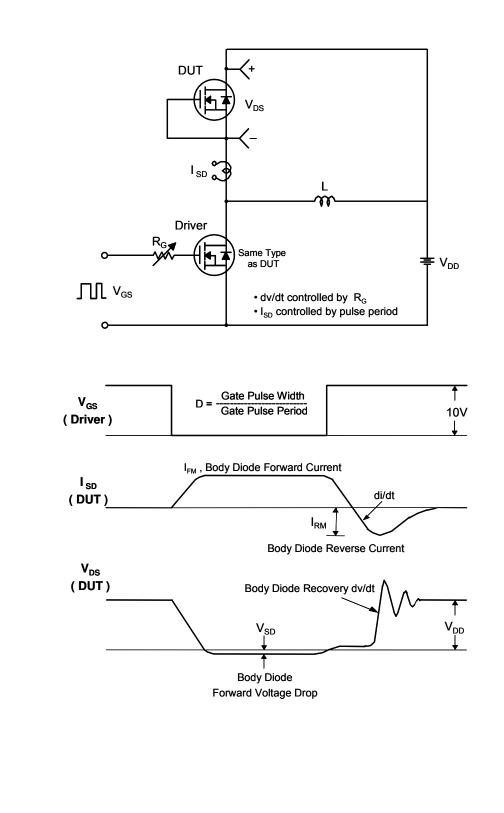
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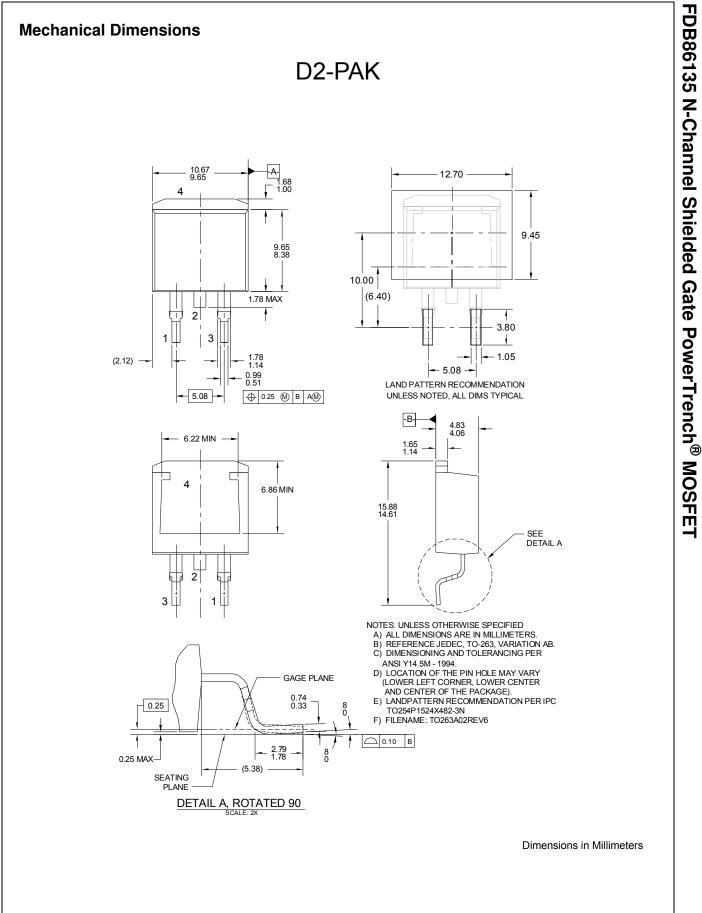
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Peak Diode Recovery dv/dt Test Circuit & Waveforms







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